## FEATURES

- Wide Bandwidth
(BW = 900 MHz Typ, 1.8 Gbps)
- Low Crosstalk ( $\mathrm{X}_{\text {TALK }}=-41 \mathrm{~dB}$ Typ)
- Low Bit-to-Bit Skew ( $\mathrm{t}_{\text {sk(o) }}=0.2 \mathrm{~ns}$ Max)
- Low and Flat ON-State Resistance
( $r_{\text {on }}=4 \Omega$ Typ, $r_{\text {on(flat) }}=0.7 \Omega$ Typ)
- Low Input/Output Capacitance
( $\mathrm{C}_{\mathrm{ON}}=10 \mathrm{pF}$ Typ)
- Rail-to-Rail Switching on Data I/O Ports (0 to 5 V )
- $\mathrm{V}_{\mathrm{DD}}$ Operating Range From 3 V to 3.6 V
- $I_{\text {off }}$ Supports Partial-Power-Down Mode Operation
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Performance Tested Per JESD 22
- 2000-V Human-Body Model (A114-B, Class II)
- 1000-V Charged-Device Model (C101)
- Applications
- Digital Video Signal Switching
- Differential DVI, HDMI Signal Muxing for Audio/Video Receivers and High Definition Television (HDTV)


NC - No internal connection

## DESCRIPTION/ORDERING INFORMATION

The TS3DV416 is a 16 -bit to 8 -bit multiplexer/demultiplexer digital video switch with a single select (SEL) input. SEL controls the data path of the multiplexer/demultiplexer.
The device provides a low and flat on-state resistance ( $\mathrm{r}_{\mathrm{on}}$ ) and an excellent on-resistance match. Low input/output capacitance, high-bandwidth, low skew, and low crosstalk among channels make this device suitable for various digital video applications, such as DVI and HDMI.

TYPICAL APPLICATION
DVD Player


FOR DVI/HDMI APPLICATIONS

## ORDERING INFORMATION

| $\mathbf{T}_{\mathbf{A}}$ | PACKAGE $^{(1)}$ |  | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
| :---: | :--- | :--- | :--- | :--- |
| $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ | TSSOP - DGG | Tape and reel | TS3DV416DGGR | TBD |
|  | TVSOP - DGV | Tape and reel | TS3DV416DGVR | TBD |

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

FUNCTION TABLE

| INPUT <br> SEL | INPUT/ <br> OUTPUT <br> An | FUNCTION |  |
| :---: | :---: | :---: | :---: |
| L | $\mathrm{nB}_{1}$ | $\mathrm{~A}_{\mathrm{n}}=\mathrm{nB}_{1}$ | $\mathrm{nB}_{2}$ high-impedance mode |
| H | $\mathrm{nB}_{2}$ | $\mathrm{~A}_{\mathrm{n}}=\mathrm{nB}_{2}$ | $\mathrm{nB}_{1}$ high-impedance mode |

## PIN DESCRIPTION

| NAME | DESCRIPTION |
| :---: | :---: |
| $\mathrm{A}_{\mathrm{n}}$ | Data I/O |
| $\mathrm{nB}_{\mathrm{m}}$ | Data I/O |
| SEL | Select input |

## LOGIC DIAGRAM (POSITIVE LOGIC)

 FOR DVI/HDMI APPLICATIONS

## Absolute Maximum Ratings ${ }^{(1)}$

over operating free-air temperature range (unless otherwise noted)

|  |  |  | MIN | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{CC}}$ | Supply voltage range |  | -0.5 | 4.6 | V |
| $\mathrm{V}_{\text {IN }}$ | Control input voltage range ${ }^{(2)(3)}$ |  | -0.5 | 7 | V |
| $\mathrm{V}_{1 / \mathrm{O}}$ | Switch I/O voltage range ${ }^{(2)(3)(4)}$ |  | -0.5 | 7 | V |
| $\mathrm{I}_{\mathrm{IK}}$ | Control input clamp current | $\mathrm{V}_{\text {IN }}<0$ |  | -50 | mA |
| I/OK | I/O port clamp current | $\mathrm{V}_{1 / \mathrm{O}}<0$ |  | -50 | mA |
| $\mathrm{I}_{1 / \mathrm{O}}$ | ON-state switch current ${ }^{(5)}$ |  |  | $\pm 128$ | mA |
|  | Continuous current through $\mathrm{V}_{\text {CC }}$ |  |  | $\pm 100$ | mA |
|  | Package thermal impedance ${ }^{(6)}$ | DGG package |  | 70 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
|  | Package thermar impedance | DGV package |  | 58 | C/w |
| $\mathrm{T}_{\text {stg }}$ | Storage temperature range |  | -65 | 150 | ${ }^{\circ} \mathrm{C}$ |

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
(2) All voltages are with respect to ground, unless otherwise specified.
(3) The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
(4) $V_{1}$ and $V_{O}$ are used to denote specific conditions for $V_{I / O}$.
(5) $\mathrm{I}_{1}$ and $\mathrm{I}_{\mathrm{O}}$ are used to denote specific conditions for $\mathrm{I}_{/ \mathrm{O}}$.
(6) The package thermal impedance is calculated in accordance with JESD 51-7.

## Recommended Operating Conditions ${ }^{(1)}$

|  |  | MIN | MAX |
| :--- | :--- | ---: | :---: |
| $\mathrm{V}_{\mathrm{CC}}$ | UNIT |  |  |
| $\mathrm{V}_{\mathrm{IH}}$ | High-level control input voltage (SEL) | 3 | 3.6 |
| $\mathrm{~V}_{\mathrm{IL}}$ | Low-level control input voltage (SEL) | 2 | 5.5 |
| $\mathrm{~V}_{\mathrm{I} / 0}$ | Input/output voltage | 0 | 0.8 |
| $\mathrm{~T}_{\mathrm{A}}$ | Operating free-air temperature | 0 | 5.5 |

(1) All unused inputs of the device must be held at $\mathrm{V}_{\mathrm{CC}}$ or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

4-CHANNEL DIFFERENTIAL 8:16 MUX SWITCH
www.ti.com

## Electrical Characteristics ${ }^{(1)}$

for high frequency switching over recommended operating free-air temperature range, $\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V} \pm 0.3 \mathrm{~V}$ (unless otherwise noted)

| PARAMETER |  | TEST CONDITIONS |  |  |  | MIN | TYP ${ }^{(2)}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{IK}}$ | SEL | $\mathrm{V}_{\mathrm{DD}}=3.6 \mathrm{~V}$, | $\mathrm{I}_{\mathrm{IN}}=-18 \mathrm{~mA}$ |  |  |  | -0.7 | -1.2 | V |
| $\mathrm{I}_{\mathrm{IH}}$ | SEL | $\mathrm{V}_{\mathrm{DD}}=3.6 \mathrm{~V}$, | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {DD }}$ |  |  |  |  | $\pm 1$ | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\text {IL }}$ | SEL | $\mathrm{V}_{\mathrm{DD}}=3.6 \mathrm{~V}$, | $\mathrm{V}_{\text {IN }}=\mathrm{GND}$ |  |  |  |  | $\pm 1$ | $\mu \mathrm{A}$ |
| $\mathrm{l}_{\text {off }}$ |  | $V_{D D}=0$ | $\mathrm{V}_{\mathrm{O}}=0$ to 3.6 V , | $V_{1}=0$ |  |  |  | 1 | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\mathrm{Cc}}$ |  | $\mathrm{V}_{\mathrm{DD}}=3.6 \mathrm{~V}$, | $\mathrm{I}_{1 / \mathrm{O}}=0$, | Switch ON or |  |  | 250 | 600 | mA |
| $\mathrm{C}_{\text {IN }}$ | SEL | $\mathrm{f}=1 \mathrm{MHz}$, | $\mathrm{V}_{\mathrm{IN}}=0$ |  |  |  | 2.5 | 3 | pF |
| $\mathrm{C}_{\text {OFF }}$ | B port | $\mathrm{V}_{1}=0$, | $\mathrm{f}=1 \mathrm{MHz}$, | Outputs open, | Switch OFF |  | 3.5 | 4 | pF |
| $\mathrm{Con}^{\text {O }}$ |  | $V_{1}=0$, | $\mathrm{f}=1 \mathrm{MHz}$, | Outputs open, | Switch ON |  | 10 | 10.9 | pF |
| $\mathrm{r}_{\mathrm{on}}$ |  | $V_{D D}=3 \mathrm{~V}$, | $1.5 \mathrm{~V} \leq \mathrm{V}_{1} \leq \mathrm{V}_{\mathrm{DD}}$, | $\mathrm{I}_{\mathrm{O}}=-40 \mathrm{~mA}$ |  |  | 4 | 8 | $\Omega$ |
| $r_{\text {on(flat })}{ }^{(3)}$ |  | $V_{D D}=3 \mathrm{~V}$, | $\mathrm{V}_{1}=1.5 \mathrm{~V}$ and $\mathrm{V}_{\mathrm{DD}}$, | $\mathrm{I}_{\mathrm{O}}=-40 \mathrm{~mA}$ |  |  | 0.7 |  | $\Omega$ |
| $\Delta \mathrm{r}_{\mathrm{on}}{ }^{(4)}$ |  | $\mathrm{V}_{\mathrm{CC}}=3 \mathrm{~V}$, | $1.5 \mathrm{~V} \leq \mathrm{V}_{1} \leq \mathrm{V}_{\mathrm{CC}}$, | $\mathrm{I}_{\mathrm{O}}=-40 \mathrm{~mA}$ |  |  | 0.2 | 1.2 | $\Omega$ |

(1) $\mathrm{V}_{\mathrm{I}}, \mathrm{V}_{\mathrm{O}}, \mathrm{I}_{\mathrm{I}}$, and $\mathrm{I}_{\mathrm{O}}$ refer to $\mathrm{I} / \mathrm{O}$ pins. $\mathrm{V}_{\mathrm{IN}}$ refers to the control inputs.
(2) All typical values are at $\mathrm{V}_{\mathrm{DD}}=3.3 \mathrm{~V}$ (unless otherwise noted), $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
(3) $r_{\text {onfllat) }}$ is the difference of $r_{\text {on }}$ in a given channel at specified voltages.
(4) $\Delta r_{\text {on }}$ is the difference of $r_{\text {on }}$ from center $\left(A_{4}, A_{5}\right)$ ports to any other port.

## Switching Characteristics

over recommended operating free-air temperature range $\mathrm{V}_{\mathrm{DD}}=3.3 \mathrm{~V} \pm 0.3 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=200 \Omega, \mathrm{C}_{\mathrm{L}}=10 \mathrm{pF}$ (unless otherwise noted) (see Figure 4 and Figure 5)

| PARAMETER | FROM (INPUT) | $\begin{gathered} \text { TO } \\ \text { (OUTPUT) } \end{gathered}$ | MIN | TYP ${ }^{(1)}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{\mathrm{pd}}{ }^{(2)}$ | A or B | B or A |  | 0.04 |  | ns |
| $\mathrm{t}_{\text {PZH }}, \mathrm{t}_{\text {PZL }}$ | SEL | A or B | 1.5 |  | 11.5 | ns |
| $\mathrm{t}_{\text {PHZ }}$, tPLZ | SEL | A or B | 1 |  | 8.5 | ns |
| $\mathrm{t}_{\text {sk(0) }}{ }^{(3)}$ | A or B | B or A |  | 0.1 | 0.2 | ns |
| $\mathrm{t}_{\text {sk(p) }}{ }^{(4)}$ |  |  |  | 0.1 | 0.2 | ns |

(1) All typical values are at $\mathrm{V}_{\mathrm{DD}}=3.3 \mathrm{~V}$ (unless otherwise noted), $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
(2) The propagation delay is the calculated RC time constant of the typical ON-state resistance of the switch and the specified load capacitance when driven by an ideal voltage source (zero output impedance).
(3) Output skew between center port $\left(\mathrm{A}_{4}\right.$ to $\left.\mathrm{A}_{5}\right)$ to any other port
(4) Skew between opposite transitions of the same output in a given device $\left|t_{\text {PHL }}-t_{\text {PLH }}\right|$

## Dynamic Characteristics

over recommended operating free-air temperature range $\mathrm{V}_{\mathrm{DD}}=3.3 \mathrm{~V} \pm 0.3 \mathrm{~V}$ (unless otherwise noted)

| PARAMETER | TEST CONDITIONS |  |  |  |  |  |  |  |  | SYP(1) | UNIT |
| :---: | :--- | :--- | :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{X}_{\text {TALK }}$ | $\mathrm{R}_{\mathrm{L}}=100 \Omega$, | $\mathrm{f}=250 \mathrm{MHz}$, | See Figure 7 | -41 | dB |  |  |  |  |  |  |
| $\mathrm{O}_{\text {IRR }}$ | $\mathrm{R}_{\mathrm{L}}=100 \Omega$, | $\mathrm{f}=250 \mathrm{MHz}$, | See Figure 8 | -39 | dB |  |  |  |  |  |  |
| BW | See Figure 6 |  |  | 900 | MHz |  |  |  |  |  |  |

[^0]OPERATING CHARACTERISTICS


- Gain at $900 \mathrm{MHz}, \mathbf{- 3 d B}$

Figure 1. Gain vs Frequency


■ OFF Isolation at $250 \mathrm{MHz},-39 \mathrm{~dB}$
Figure 2. OFF Isolation vs Frequency

## OPERATING CHARACTERISTICS



■ Crosstalk at $250 \mathrm{MHz},-41 \mathrm{~dB}$
Figure 3. Crosstalk vs Frequency FOR DVI/HDMI APPLICATIONS

## APPLICATION INFORMATION

DVI Connector 2
(Single Link)

TMDS Data 2 TMDS Data 2+

TMDS Data 1 TMDS Data 1+

TMDS Data 0 -
TMDS Data $0+$
TMDS Clock+
TMDS Clock -

DVI Connector 1
(Single Link) TMDS Data $2-$
TMDS Data $2+$

TMDS Data 1 -
TMDS Data 1+

TMDS Data 0 TMDS Data 0+

TMDS Clock+
TMDS Clock -
$\qquad$

Typical DVI Connector

| DVI Connector Pin Assignments |  |  |
| :---: | :--- | :--- |
| Pin | Name | Function |
| $\mathbf{1}$ | TMDS Data 2- | Digital red - (Link 1) |
| $\mathbf{2}$ | TMDS Data 2+ | Digital red + (Link 1) |
| $\mathbf{3}$ | TMDS Data 2/4 shield |  |
| $\mathbf{4}$ | TMDS Data 4- | Digital green - (Link 2) |
| $\mathbf{5}$ | TMDS Data 4+ | Digital green + (Link 2) |
| $\mathbf{6}$ | DDC clock |  |
| $\mathbf{7}$ | DDC data |  |
| $\mathbf{8}$ | Analog Vertical Sync |  |
| $\mathbf{9}$ | TMDS Data 1- | Digital green - (Link 1) |
| $\mathbf{1 0}$ | TMDS Data 1+ | Digital green + (Link 1) |
| $\mathbf{1 4}$ | TMDS Data 1/3 shield |  |
| $\mathbf{1 2}$ | TMDS Data 3- | Digital blue - (Link 2) |
| $\mathbf{1 3}$ | TMDS Data 3+ | Digital blue + (Link 2) |
| $\mathbf{1 4}$ | +5V | Power for monitor when in standby |
| $\mathbf{1 5}$ | Ground | Return for pin 14 and analog sync |
| $\mathbf{1 6}$ | Hot Plug Detect |  |
| $\mathbf{1 7}$ | TMDS data 0- | Digital blue - (Link 1) and digital sync |
| $\mathbf{1 8}$ | TMDS data 0+ | Digital blue + (Link 1) and digital sync |
| 19 | TMDS data 0/5 shield |  |
| $\mathbf{2 0}$ | TMDS data 5- | Digital red - (Link 2) |
| $\mathbf{2 1}$ | TMDS data 5+ | Digital red + (Link 2) |
| $\mathbf{2 2}$ | TMDS clock shield |  |
| $\mathbf{2 3}$ | TMDS clock+ | Digital clock + (Links 1 and 2) |
| $\mathbf{2 4}$ | TMDS clock- | Digital clock - (Links 1 and 2) |
| $\mathbf{C 1}$ | Analog Red |  |
| C2 | Analog Green |  |
| C3 | Analog Blue |  |
| $\mathbf{C 4}$ | Analog Horizontal Sync |  |
| $\mathbf{C 5}$ | Analog Ground | Return for R, G and B signals |
|  |  |  |



|  |  |  |  |  |  |  |  |  | ${ }^{C 1} \mathrm{Cl}^{2}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | 10 | 11 | ${ }^{12}$ | 13 | 1 | 14 | 15 | 16 | C5 |
|  | 18 | 19 | 20 | 2 | 2 | 22 | 23 | ${ }^{24}$ | C3, ${ }^{\text {c }}$ |

The TS3DV416 can be used to switch between two digital video ports.


## PARAMETER MEASUREMENT INFORMATION (Enable and Disable Times)



| TEST | $\mathrm{V}_{\mathrm{DD}}$ | S 1 | $\mathrm{R}_{\mathrm{L}}$ | $\mathrm{V}_{\mathbf{I}}$ | $\mathrm{C}_{\mathrm{L}}$ | $\mathrm{V}_{\Delta}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{\text {PLZ }} / \mathrm{t}_{\text {PZL }}$ | $3.3 \mathrm{~V} \pm 0.3 \mathrm{~V}$ | $2 \times \mathrm{V}_{\mathrm{DD}}$ | $200 \Omega$ | GND | 10 pF | 0.3 V |
| $\mathrm{t}_{\text {PHZ }} / \mathrm{t}_{\text {PZH }}$ | $3.3 \mathrm{~V} \pm 0.3 \mathrm{~V}$ | GND | $200 \Omega$ | $\mathrm{~V}_{\mathrm{DD}}$ | 10 pF | 0.3 V |



VOLTAGE WAVEFORMS ENABLE AND DISABLE TIMES

NOTES: A. $\mathrm{C}_{\mathrm{L}}$ includes probe and jig capacitance.
B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
C. All input pulses are supplied by generators having the following characteristics: PRR $\leq 10 \mathrm{MHz}, \mathrm{Z}_{\mathrm{O}}=50 \Omega, \mathrm{t}_{\mathrm{r}} \leq 2.5 \mathrm{~ns}, \mathrm{t}_{\mathrm{f}} \leq 2.5 \mathrm{~ns}$.
D. The outputs are measured one at a time, with one transition per measurement.
E. $t_{P L Z}$ and $t_{P H Z}$ are the same as $t_{\text {dis }}$.
F. $t_{P Z L}$ and $t_{P Z H}$ are the same as $t_{\text {en }}$.

Figure 4. Test Circuit and Voltage Waveforms

## PARAMETER MEASUREMENT INFORMATION

 (Skew)

NOTES: A. $\mathrm{C}_{\mathrm{L}}$ includes probe and jig capacitance.
B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
C. All input pulses are supplied by generators having the following characteristics: PRR $\leq 10 \mathrm{MHz}, \mathrm{Z}_{\mathrm{O}}=50 \Omega, \mathrm{t}_{\mathrm{r}} \leq 2.5 \mathrm{~ns}, \mathrm{t}_{\mathrm{f}} \leq 2.5 \mathrm{~ns}$.
D. The outputs are measured one at a time, with one transition per measurement.

Figure 5. Test Circuit and Voltage Waveforms

## PARAMETER MEASUREMENT INFORMATION



NOTE A: $C_{L}$ includes probe and jig capacitance.
Figure 6. Test Circuit for Frequency Response (BW)
Frequency response is measured at the output of the ON channel. For example, when $\mathrm{V}_{\text {SEL }}=0$ and $\mathrm{A}_{0}$ is the input, the output is measured at $0 \mathrm{~B}_{1}$. All unused analog I/O ports are left open.
HP8753ES Setup
Average $=4$
RBW $=3 \mathrm{kHz}$
$\mathrm{V}_{\text {BIAS }}=0.35 \mathrm{~V}$
ST $=2 \mathrm{~s}$
P1 $=0 \mathrm{dBM}$

## PARAMETER MEASUREMENT INFORMATION



NOTES: A. $C_{L}$ includes probe and jig capacitance.
B. A $50-\Omega$ termination resistor is needed to match the loading of the network analyzer.

Figure 7. Test Circuit for Crosstalk ( $\mathrm{X}_{\text {TALK }}$ )
Crosstalk is measured at the output of the nonadjacent $O N$ channel. For example, when $\mathrm{V}_{\text {SEL }}=0$ and $\mathrm{A}_{1}$ is the input, the output is measured at $A_{3}$. All unused analog input (A) ports are connected to GND, and output (B) ports are left open.
HP8753ES Setup
Average $=4$
RBW $=3 \mathrm{kHz}$
$\mathrm{V}_{\text {BIAS }}=0.35 \mathrm{~V}$
ST $=2 \mathrm{~s}$
P1 $=0 \mathrm{dBM}$

## PARAMETER MEASUREMENT INFORMATION



NOTES: A. $C_{L}$ includes probe and jig capacitance.
B. A $50-\Omega$ termination resistor is needed to match the loading of the network analyzer.

Figure 8. Test Circuit for OFF Isolation ( $\mathrm{O}_{\mathrm{IRR}}$ )
OFF isolation is measured at the output of the OFF channel. For example, when $V_{S E L}=G N D$ and $A_{1}$ is the input, the output is measured at $1 \mathrm{~B}_{2}$. All unused analog input (A) ports are connected to ground, and output (B) ports are left open.

## HP8753ES Setup

Average $=4$
RBW $=3 \mathrm{kHz}$
$\mathrm{V}_{\text {BIAS }}=0.35 \mathrm{~V}$
ST $=2 \mathrm{~s}$
P1 $=0 \mathrm{dBM}$

## PACKAGING INFORMATION

| Orderable Device | Status $^{(1)}$ | Package <br> Type | Package <br> Drawing | Pins Package <br> Qty | Eco Plan ${ }^{(2)}$ | Lead/Ball Finish | MSL Peak Temp ${ }^{(3)}$ |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| TS3DV416DGGR | ACTIVE | TSSOP | DGG | 48 | 2000 |  <br> no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TS3DV416DGGRE4 | ACTIVE | TSSOP | DGG | 48 | 2000 |  <br> no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TS3DV416DGVR | ACTIVE | TVSOP | DGV | 48 | 2000 <br> no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |  |

${ }^{(1)}$ The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.
${ }^{(2)}$ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS \& no $\mathrm{Sb} / \mathrm{Br}$ ) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb -Free/Green conversion plan has not been defined.
Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed $0.1 \%$ by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb -Free products are suitable for use in specified lead-free processes.
Green (RoHS \& no $\mathbf{S b} / \mathrm{Br}$ ): Tl defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine ( Br ) and Antimony ( Sb ) based flame retardants ( Br or Sb do not exceed $0.1 \%$ by weight in homogeneous material)
${ }^{(3)}$ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

Important Information and Disclaimer:The information provided on this page represents Tl's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall Tl's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.


| PIM ** | $\mathbf{1 4}$ | $\mathbf{1 6}$ | $\mathbf{2 0}$ | $\mathbf{2 4}$ | $\mathbf{3 8}$ | $\mathbf{4 8}$ | $\mathbf{5 6}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| A MAX | 3,70 | 3,70 | 5,10 | 5,10 | 7,90 | 9,80 | 11,40 |
| A MIN | 3,50 | 3,50 | 4,90 | 4,90 | 7,70 | 9,60 | 11,20 |

NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.
D. Falls within JEDEC: $24 / 48$ Pins - MO-153

14/16/20/56 Pins - MO-194

48 PINS SHOWN


NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold protrusion not to exceed 0,15.
D. Falls within JEDEC MO-153

## IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to Tl's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with Tl's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI .

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. Tl is not responsible or liable for such altered documentation.

Resale of Tl products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. Tl is not responsible or liable for any such statements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

## Products

## Applications

| Amplifiers | amplifier.ti.com | Audio | www.ti.com/audio |
| :--- | :--- | :--- | :--- |
| Data Converters | dataconverter.ti.com | Automotive | www.ti.com/automotive |
| DSP | dsp.ti.com | Broadband | www.ti.com/broadband |
| Interface | interface.ti.com | Digital Control | www.ti.com/digitalcontrol |
| Logic | logic.ti.com | Military | www.ti.com/military |
| Power Mgmt | power.ti.com | Optical Networking | www.ti.com/opticalnetwork |
| Microcontrollers | microcontroller.ti.com | Security | www.ti.com/security |
|  |  | Telephony | www.ti.com/telephony |
|  |  | Video \& Imaging | www.ti.com/video |
|  |  | Wireless | www.ti.com/wireless |

Mailing Address: Texas Instruments<br>Post Office Box 655303 Dallas, Texas 75265

Copyright © 2005, Texas Instruments Incorporated


[^0]:    (1) All typical values are at $\mathrm{V}_{\mathrm{DD}}=3.3 \mathrm{~V}$ (unless otherwise noted), $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.

